

**(19) World Intellectual Property
Organization
International Bureau**



(43) International Publication Date
14 April 2005 (14.04.2005)

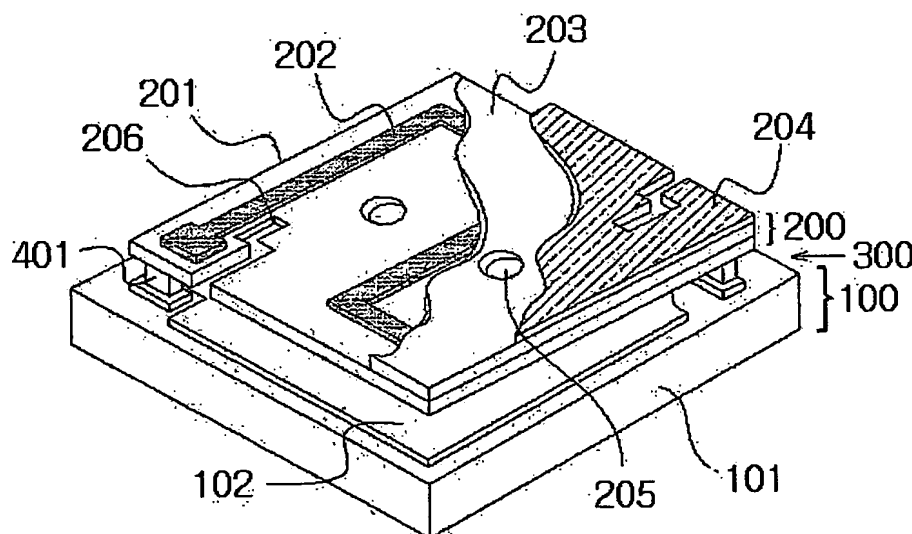
PCT

(10) International Publication Number
WO 2005/034248 A1

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| <p>(51) International Patent Classification⁷:
G01J 1/02</p> <p>(21) International Application Number:
PCT/KR2004/002294</p> <p>(22) International Filing Date:
9 September 2004 (09.09.2004)</p> <p>(25) Filing Language:
Korean</p> <p>(26) Publication Language:
English</p> <p>(30) Priority Data:
10-2003-0070410 9 October 2003 (09.10.2003) KR
10-2004-0061285 4 August 2004 (04.08.2004) KR
10-2004-0070714
6 September 2004 (06.09.2004) KR</p> <p>(71) Applicant (for all designated States except US): OCAS CORP. [KR/KR]; Rm206P1-Dong, KyonggiTechnoPark, 1271-11 Sa-dong, Ansan, Gyeonggi-do 426-170 (KR).</p> | <p>(72) Inventors; and
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[Continued on next page]

(54) Title: BOLOMETRIC INFRARED SENSOR HAVING TWO LAYER STRUCTURE AND METHOD FOR MANUFACTURING THE SAME



(57) Abstract: The present disclosure is related to bolometric infrared sensors having a two-layer structure and methods for manufacturing the same for improving an absorption rate by a spectroscopic design for resonantly absorbing infrared, and preventing the deformation of a sensor caused by stresses due to heat. The infrared sensor including an ROIC substrate and several pixels, comprises: a bottom layer including a reflective metal layer on the ROTC substrate; a cavity for resonantly absorbing infrared ray over the bottom layer; an upper layer of a sandwich shape including an absorption-transmission layer having a cutting area in the middle thereof and a bolometer layer placed both on and under the absorption-transmission layer, and anchors positioned at the edges of the pixel for supporting the upper layer and functioning as electrodes.

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GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IT, LU, MC, NL, PL, PT, RO, SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).

Published:

— with international search report

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